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Docket No.: 50090-465

PATENT

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of

Masaki WATANABE

Serial No.: Divisional of  
Appln. Serial No. 09/484,024

Group Art Unit: To be assigned

Filed: March 04, 2002

Examiner: To be assigned

For: PACKAGE FOR ACCOMMODATING ELECTRONIC PARTS, SEMICONDUCTOR DEVICE  
AND METHOD FOR MANUFACTURING PACKAGE

**PRELIMINARY AMENDMENT**

Commissioner for Patents  
Washington, DC 20231

Sir:

Prior to examination of the above-referenced application, please amend the application as follows:

IN THE SPECIFICATION:

On page 1 of the specification, after the title, insert the following:

--This application is a divisional of U.S. Patent Application Serial No. 09/484,024, filed January 18, 2000.--

**REMARKS**

The above amendment to the specification has been made in order to include the prior application information. Entry of this Preliminary Amendment is respectfully requested.

Respectfully submitted,

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